









### **■** Features

- · Universal AC input / Full range
- No load power consumption<0.075W</li>
- Compact size
- Comply with BS EN/EN55032 Class B without any additional components
- · Protections: Short circuit / Overload / Over voltage
- · Cooling by free air convection
- · Isolation Class II
- · High reliability, low cost
- 3 years warranty

# Applications

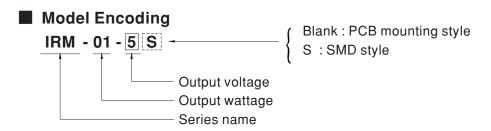
- · Industrial electrical equipment
- Mechanical equipment
- Factory automation equipment
- · Handheld electronic device

### GTIN CODE

 $\textbf{MW Search:} \ \underline{\textbf{https://www.meanwell.com/serviceGTIN.aspx}}$ 

# Description

IRM-01 is a 1W miniature (33.7\*22.2\*15mm) AC-DC module-type power supply, ready to be soldered onto the PCB boards of various kinds of electronic instruments or industrial automation equipments. This product allows a universal input voltage range of 85~305Vac. The phenolic case and potted with silicone enhance the heat dissipation and meet the anti-vibration demand up to 5G; moreover, it provides the fundamental resistance to dust and moisture. With the high efficiency up to 77% and the extremely low no-load power consumption below 0.075W, IRM-01 series fulfills the worldwide regulation for the low power consumption requirement for electronics. The entire series is a Class II design (no FG pin), incorporating the built-in EMI filtering components, enabling the compliance with BS EN/EN55032 Class B; the supreme EMC features keep the end electronic units from electromagnetic interference. In addition to module-type model, IRM-01 series also offers the SMD style model.

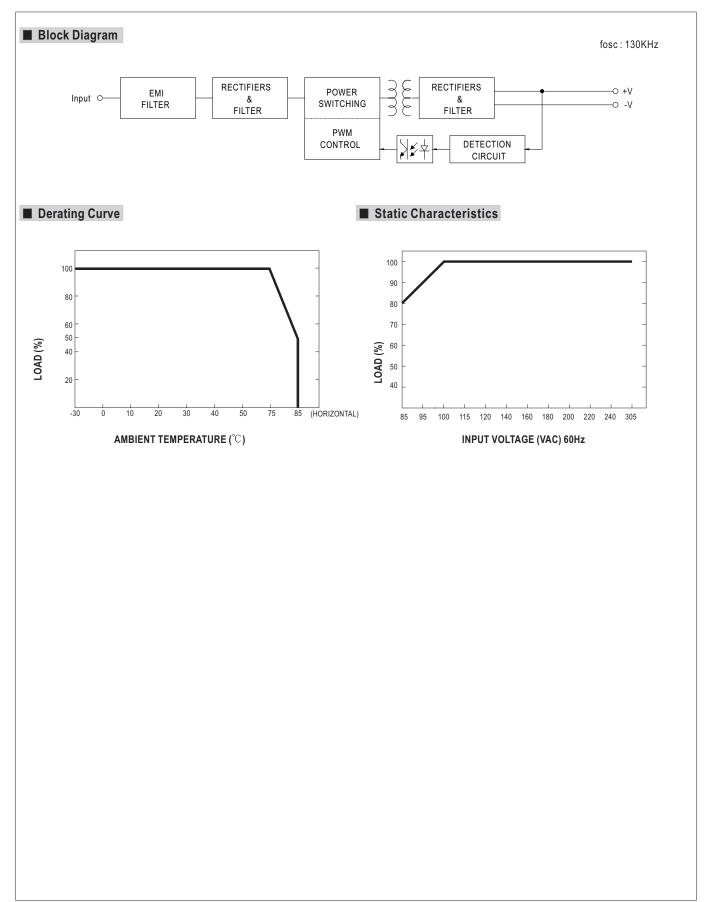




# **SPECIFICATION**

MODEL		IRM-01-3.3	IRM-01-5	IRM-01-9	IRM-01-12	IRM-01-15	IRM-01-24	
OUTPUT	DC VOLTAGE	3.3V	5V	9V	12V	15V	24V	
	RATED CURRENT	300mA	200mA	111mA	83mA	67mA	42mA	
	CURRENT RANGE	0 ~ 300mA	0 ~ 200mA	0 ~ 111mA	0 ~ 83mA	0 ~ 67mA	0 ~ 42mA	
	RATED POWER	1W	1W	1W	1W	1W	1W	
	RIPPLE & NOISE (max.) Note.2	150mVp-p	150mVp-p	150mVp-p	150mVp-p	200mVp-p	200mVp-p	
	VOLTAGE TOLERANCE Note.3	±2.5%	±2.5%	±2.5%	±2.5%	±2.5%	±2.5%	
	LINE REGULATION	±0.5%	±0.5%	±0.5%	±0.5%	±0.5%	±0.5%	
	LOAD REGULATION	±0.5%	±0.5%	±0.5%	±0.5%	±0.5%	±0.5%	
	SETUP, RISE TIME	600ms, 30ms/230Vac 600ms, 30ms/115Vac at full load						
	HOLD UP TIME (Typ.)	40ms/230Vac 12ms/115Vac at full load						
INPUT	VOLTAGE RANGE	85 ~ 305Vac 120 ~ 430Vdc						
	FREQUENCY RANGE	47 ~ 63Hz						
	EFFICIENCY (Typ.)	66%	70%	72%	74%	75%	77%	
	AC CURRENT (Typ.)	25mA/115Vac 18mA/230Vac 16mA/277Vac						
	INRUSH CURRENT (Typ.)	5A/115Vac 10A/230Vac						
	LEAKAGE CURRENT	< 0.25mA/277Vac						
PROTECTION	OVERLOAD	≥110% rated output power						
		Protection type: Hiccup mode, recovers automatically after fault condition is removed						
	OVER VOLTAGE	3.8 ~ 4.9V	5.2 ~ 6.8V	10.3 ~ 12.2V	12.6 ~ 16.2V	15.7 ~ 20.3V	25.2 ~ 32.4V	
		Protection type : Shut off o/p voltage, clamping by zener diode						
ENVIRONMENT	WORKING TEMP.	-30 ~ +85 °C (Refer to "Derating Curve")						
	WORKING HUMIDITY	20 ~ 90% RH non-condensing						
	STORAGE TEMP., HUMIDITY	-40 ~ +100°C, 10 ~ 95% RH						
	TEMP. COEFFICIENT	±0.03%/°C (0~75°C)						
	VIBRATION	10 ~ 500Hz, 5G 10min./1cycle, period for 60min. each along X, Y, Z axes						
	SOLDERING TEMPERATURE	$Wave \ soldering: 265^{\circ}C, 5s \ (max.); \ Manual \ soldering: 390^{\circ}C, 3s \ (max.); \ Reflow \ soldering(SMD \ style): 240^{\circ}C, 10s \ (max.); \ Reflow \ soldering: 390^{\circ}C, 3s \ (max.); \ Reflow \ soldering: 390^{\circ}C, 10s \ (max.); \ Reflow \ sol$						
SAFETY & EMC	SAFETY STANDARDS	UL62368-1, TUVBSEN/EN62368-1, EACTPTC004, BSMICNS15598-1approved, DesignrefertoBSEN/EN61558-1/-2-16						
	WITHSTAND VOLTAGE	I/P-O/P:3KVac						
	ISOLATION RESISTANCE	I/P-O/P:100M Ohms / 500Vdc / 25°C / 70% RH						
	EMC EMISSION	Compliance to BS EN/EN55032 (CISPR32) Class B, BS EN/EN61000-3-2,-3, EAC TP TC 020, CNS15936 Class B						
	EMC IMMUNITY	Compliance to BS EN/EN61000-4-2,3,4,5,6,8,11, BS EN/EN55035, heavy industry level (surge L-N:1KV), EAC TP TC 020						
OTHERS	MTBF	13571.4K hrs min. Telcordia SR-332 (Bellcore) ; 1960.2K hrs min. MIL-HDBK-217F ( $25^{\circ}$ C)						
	DIMENSION	PCB mounting style : 33.7*22.2*15mm (L*W*H) SMD style : 33.7*22.2*16mm (L*W*H)						
	PACKING	PCB mounting style	: 0.024Kg; 640pcs/ 16	.3 Kg/ 0.84CUFT	SMD style: 0.024	1Kg; 640 pcs/ 16.3 Kg	g/ 0.84CUFT	
NOTE 1. All parameters NOT specially mentioned are measured at 230VAC input, rated load				and 25 $^\circ \! \mathbb{C}$ of ambient	temperature.			
	2. Ripple & noise are measured at 20MHz of bandwidth by using a 12" twisted pair-wire terminated with a 0.1uf & 47uf parallel capacitor.							
	3. Tolerance : includes set up tolerance, line regulation and load regulation.							
	4. The ambient temperature derating of 3.5°C/1000m with fanless models and of 5°C/1000m with fan models for operating altitude higher							
	than 2000m(6500ft).	With the control of the control o						
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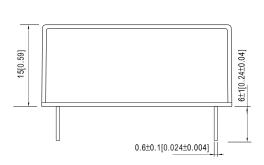


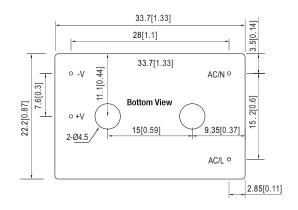
### ■ Mechanical Specification

(Unit:mm[inch], Tolerance:±0.5[±0.02])

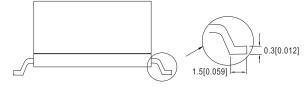
 $\bigcirc$  PCB mounting style

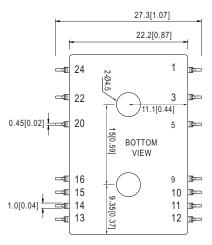
Case No.IRM02

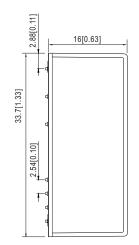




O SMD style

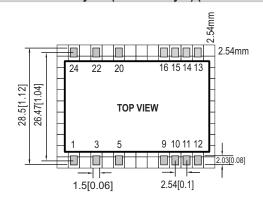


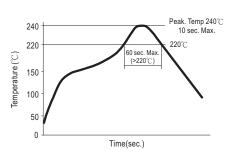




Pin No.	Assignment		
1	AC/L		
24	AC/N		
13	-Vo		
12	+Vo		
others	N.C.		

## ■ Recommended PCB Layout (for SMD style) (Reflow soldering method available)





Remark : The curve applies only to the "Hot Air Reflow Soldering"

### **■** Installation Manual

Please refer to: http://www.meanwell.com/manual.html